

# Hyper 3 mm (T1) LED, Diffused Hyper-Bright, Wide-Angle LED

LS 3386, LA 3386, LO 3386, LY 3386



## Besondere Merkmale

- **Gehäusotyp:** eingefärbtes, diffuses 3 mm (T1) Gehäuse
- **Besonderheit des Bauteils:** Lötspieße mit Aufsetzebene
- **Wellenlänge:** 632 nm (super-rot), 615 nm (amber), 605 nm (orange), 587 nm (gelb)
- **Abstrahlwinkel:** 100°
- **Technologie:** InGaAlP
- **optischer Wirkungsgrad:** 11 lm/W (gelb, orange, amber), 7 lm/W (super-rot)
- **Gruppierungsparameter:** Lichtstärke
- **Lötmethode:** Wellenlöten (TTW)
- **Vorbehandlung:** nach JEDEC Level 2
- **Verpackung:** Schüttgut, gegurtet lieferbar

## Anwendungen

- optischer Indikator
- Hinterleuchtung (Tasten, Displays, Werbebeleuchtung, Allgemeinbeleuchtung)
- Innenbeleuchtung im Automobilbereich (z.B. Tastenbeleuchtung, u.ä.)
- Markierungsbeleuchtung (z.B. Stufen, Fluchtwege, u.ä.)
- Signal- und Symbolleuchten

## Features

- **package:** colored, diffused 3 mm (T1) package
- **feature of the device:** solder leads with stand-off
- **wavelength:** 632 nm (super-red), 615 nm (amber), 605 nm (orange), 587 nm (yellow)
- **viewing angle:** 100°
- **technology:** InGaAlP
- **optical efficiency:** 11 lm/W (yellow, orange, amber), 7 lm/W (super-red)
- **grouping parameter:** luminous intensity
- **soldering methods:** TTW soldering
- **preconditioning:** acc. to JEDEC Level 2
- **packing:** bulk, available taped on reel

## Applications

- coupling into light guides
- backlighting (keys, displays, illuminated advertising, general lighting)
- interior automotive lighting (e.g. key backlighting, etc.)
- marker lights (e.g. steps, exit ways, etc.)
- signal and symbol luminaire

Typ Type	Emissions- farbe Color of Emission	Gehäuse- farbe Color of Package	Lichtstärke Luminous Intensity $I_F = 20 \text{ mA}$ $I_V \text{ (mcd)}$	Lichtstrom Luminous Flux $I_F = 20 \text{ mA}$ $\Phi_V \text{ (mlm)}$	Bestellnummer Ordering Code
LS 3386-LP LS 3386-M LS 3386-N LS 3386-P LS 3386-MQ	super-red	red diffused	11.2 ... 71.0 18.0 ... 28.0 28.0 ... 45.0 45.0 ... 71.0 18.0 ... 112.0	360 (typ.) 190 (typ.) 300 (typ.) 480 (typ.) 560 (typ.)	Q62703-Q3579 Q62703-Q3581 Q62703-Q3582 Q62703-Q3709 Q62703-Q3580
LA 3386-MQ LA 3386-N LA 3386-P LA 3386-Q LA 3386-NR	amber	orange diffused	18.0 ... 112.0 28.0 ... 45.0 45.0 ... 71.0 71.0 ... 112.0 28.0 ... 180.0	530 (typ.) 280 (typ.) 450 (typ.) 700 (typ.) 840 (typ.)	Q62703-Q3886 Q62703-Q3887 Q62703-Q3888 Q62703-Q3889 Q62703-Q3890
LO 3386-MQ LO 3386-N LO 3386-P LO 3386-Q LO 3386-NR	orange	orange diffused	18.0 ... 112.0 28.0 ... 45.0 45.0 ... 71.0 71.0 ... 112.0 28.0 ... 180.0	530 (typ.) 280 (typ.) 450 (typ.) 700 (typ.) 840 (typ.)	Q62703-Q3891 Q62703-Q3892 Q62703-Q3893 Q62703-Q3894 Q62703-Q3895
LY 3386-MQ LY 3386-N LY 3386-P LY 3386-Q LY 3386-NR	yellow	yellow diffused	18.0 ... 112.0 28.0 ... 45.0 45.0 ... 71.0 71.0 ... 112.0 28.0 ... 180.0	530 (typ.) 280 (typ.) 450 (typ.) 700 (typ.) 840 (typ.)	Q62703-Q3896 Q62703-Q3897 Q62703-Q3898 Q62703-Q3899 Q62703-Q3900

Helligkeitswerte werden mit einer Stromeinprägungsdauer von 25 ms und einer Genauigkeit von  $\pm 11 \%$  ermittelt.  
Luminous intensity is tested at a current pulse duration of 25 ms and a tolerance of  $\pm 11 \%$ .

*Anm.: Die Standardlieferform von Serientypen beinhaltet eine untere bzw. eine obere Familiengruppe oder mindestens zwei Einzelgruppen.  
In einer Verpackungseinheit / Gurt ist immer nur eine Helligkeitsgruppe enthalten.  
Die technologiebedingte Helligkeits-Streuung der heutigen LED-Herstellprozesse über einen längeren Fertigungszeitraum (Halbleitermaterial - Chipherstellung - Montageprozess) erlaubt keine Zusage einer einzelnen Helligkeitsgruppe. Daher müssen mindestens zwei Helligkeitsgruppen vorgesehen werden!*

*Note: The standard shipping format for serial types includes a lower or upper family group or at least two individual groups.  
No packing unit / tape ever contains more than one luminous intensity group.  
Luminosity variations caused by the technology used in current LED manufacturing processes over a protracted manufacturing period (semiconductor material - chip fabrication - assembly process) mean that it is not possible to assign LEDs to a single luminous intensity group. For this reason at least two luminous intensity groups must be provided!*

**Grenzwerte**  
**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Werte Values		Einheit Unit
		LS, LO, LA	LY	
Betriebstemperatur Operating temperature range	$T_{op}$	- 55 ... + 100		°C
Lagertemperatur Storage temperature range	$T_{stg}$	- 55 ... + 100		°C
Sperrschichttemperatur Junction temperature	$T_j$	+ 100		°C
Durchlassstrom Forward current	$I_F$	30		mA
Stoßstrom Surge current $t \leq 10 \mu s, D = 0.005$	$I_{FM}$	1	0.2	A
Sperrspannung Reverse voltage	$V_R$	3		V
Leistungsaufnahme Power consumption $T_A \leq 25 \text{ °C}$	$P_{tot}$	80		mW
Wärmewiderstand Thermal resistance Sperrschicht/Umgebung Junction/ambient	$R_{th JA}$	500		K/W
Sperrschicht/Löt­pad Junction/solder point Montage auf PC-Board FR 4 (Padgröße $\geq 16 \text{ mm}^2$ ) mounted on PC board FR 4 (pad size $\geq 16 \text{ mm}^2$ ) Minimale Beinchenlänge Minimum lead length	$R_{th JS}$	280		K/W

**Kennwerte** ( $T_A = 25\text{ °C}$ )

**Characteristics**

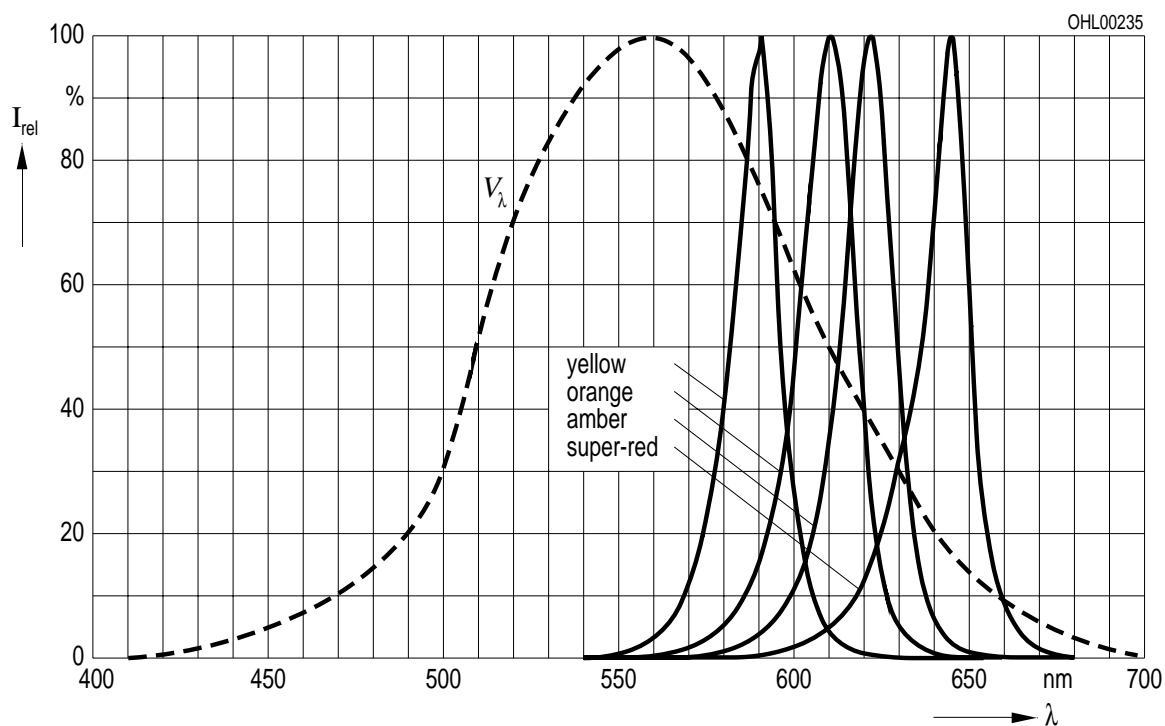
Bezeichnung Parameter	Symbol Symbol	Werte Values				Einheit Unit
		LS	LA	LO	LY	
Wellenlänge des emittierten Lichtes Wavelength at peak emission $I_F = 20\text{ mA}$	(typ.) $\lambda_{\text{peak}}$	645	622	610	591	nm
Dominantwellenlänge Dominant wavelength $I_F = 20\text{ mA}$	(typ.) $\lambda_{\text{dom}}$	632	615	605	587	nm
Spektrale Bandbreite bei 50 % $I_{\text{rel max}}$ Spectral bandwidth at 50 % $I_{\text{rel max}}$ $I_F = 20\text{ mA}$	(typ.) $\Delta\lambda$	16	16	16	15	nm
Abstrahlwinkel bei 50 % $I_V$ (Vollwinkel) Viewing angle at 50 % $I_V$	(typ.) $2\phi$	100	100	100	100	Grad deg.
Durchlassspannung <sup>1)</sup> Forward voltage <sup>1)</sup> $I_F = 20\text{ mA}$	(typ.) $V_F$ (max.) $V_F$	2.0 2.4	2.0 2.4	2.0 2.4	2.0 2.4	V V
Sperrstrom Reverse current $V_R = 3\text{ V}$	(typ.) $I_R$ (max.) $I_R$	0.01 10	0.01 10	0.01 10	0.01 10	$\mu\text{A}$ $\mu\text{A}$
Temperaturkoeffizient von $\lambda_{\text{peak}}$ Temperature coefficient of $\lambda_{\text{peak}}$ $I_F = 20\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	(typ.) $TC_{\lambda_{\text{peak}}}$	0.14	0.13	0.13	0.13	nm/K
Temperaturkoeffizient von $\lambda_{\text{dom}}$ Temperature coefficient of $\lambda_{\text{dom}}$ $I_F = 20\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	(typ.) $TC_{\lambda_{\text{dom}}}$	0.01	0.06	0.07	0.10	nm/K
Temperaturkoeffizient von $V_F$ Temperature coefficient of $V_F$ $I_F = 20\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	(typ.) $TC_V$	-2.0	-1.8	-1.7	-2.5	mV/K
Optischer Wirkungsgrad Optical efficiency $I_F = 20\text{ mA}$	(typ.) $\eta_{\text{opt}}$	7	11	11	11	lm/W

<sup>1)</sup> Spannungswerte werden mit einer Stromeinprägedauer von 1 ms und einer Genauigkeit von  $\pm 0.1\text{ V}$  ermittelt.  
Voltages are tested at a current pulse duration of 1 ms and a tolerance of  $\pm 0.1\text{ V}$ .

Relative spektrale Emission  $I_{rel} = f(\lambda)$ ,  $T_A = 25\text{ °C}$ ,  $I_F = 20\text{ mA}$

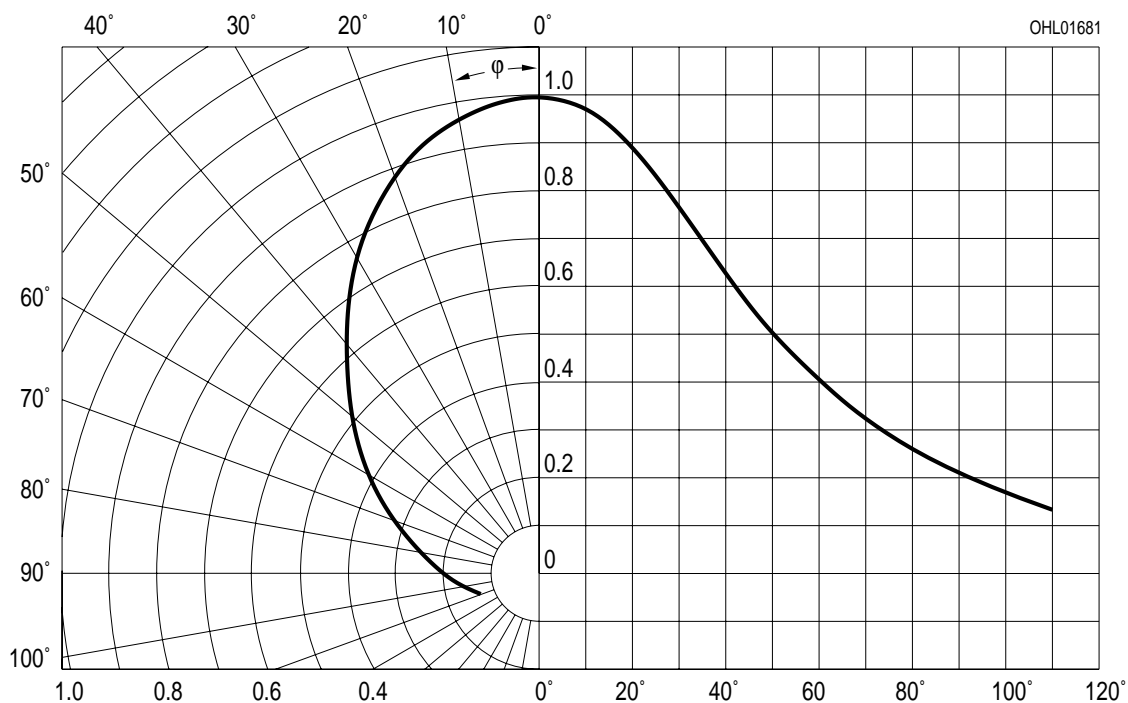
**Relative Spectral Emission**

$V(\lambda)$  = spektrale Augenempfindlichkeit  
Standard eye response curve



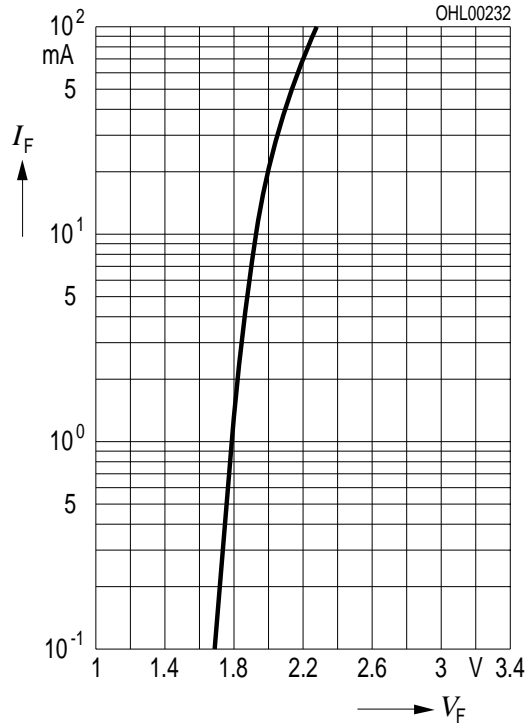
Abstrahlcharakteristik  $I_{rel} = f(\varphi)$

**Radiation Characteristic**



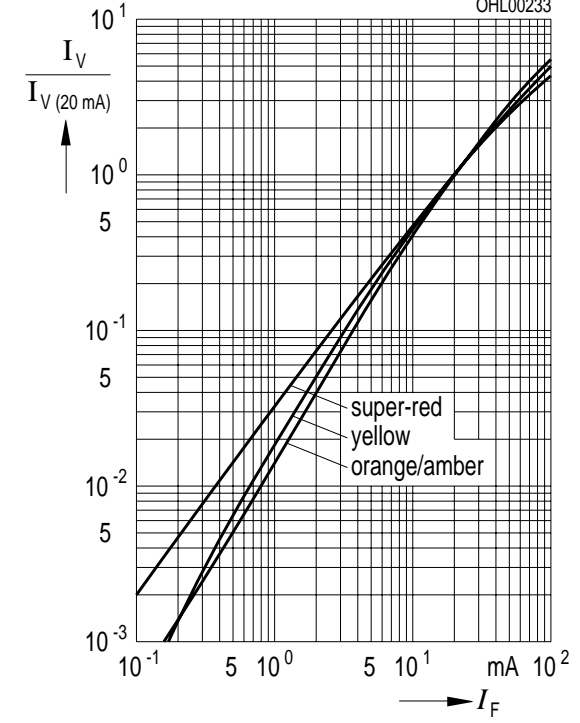
**Durchlassstrom  $I_F = f(V_F)$**   
**Forward Current**

$T_A = 25\text{ }^\circ\text{C}$

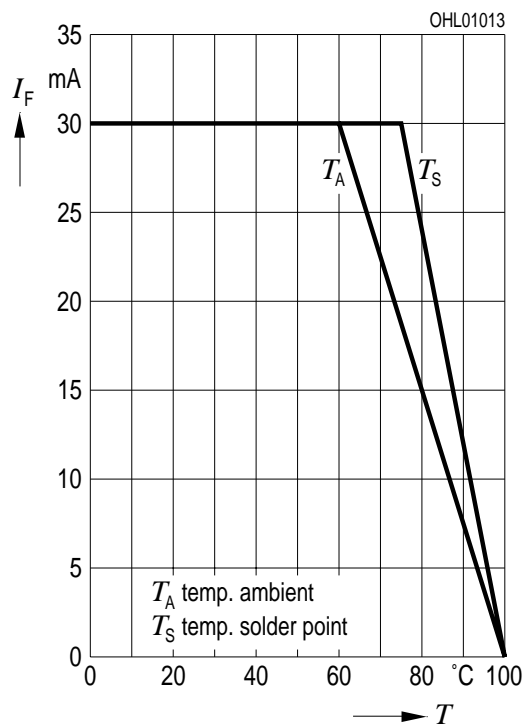


**Relative Lichtstärke  $I_V/I_{V(20\text{ mA})} = f(I_F)$**   
**Relative Luminous Intensity**

$T_A = 25\text{ }^\circ\text{C}$

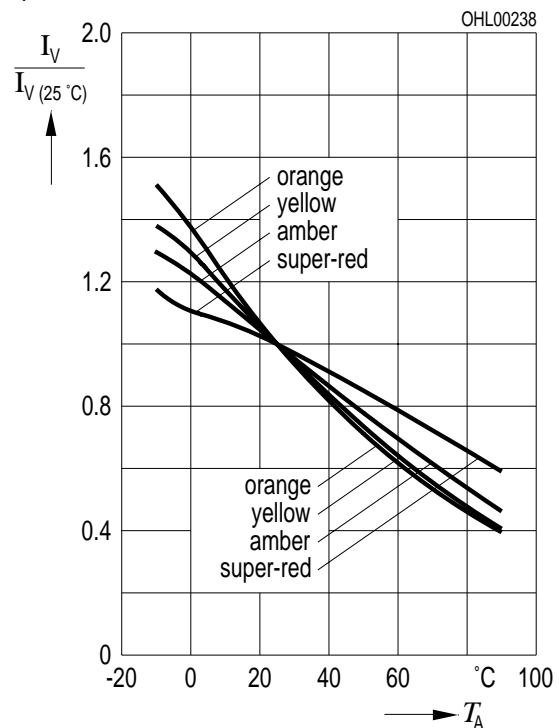


**Maximal zulässiger Durchlassstrom  $I_F = f(T)$**   
**Max. Permissible Forward Current**

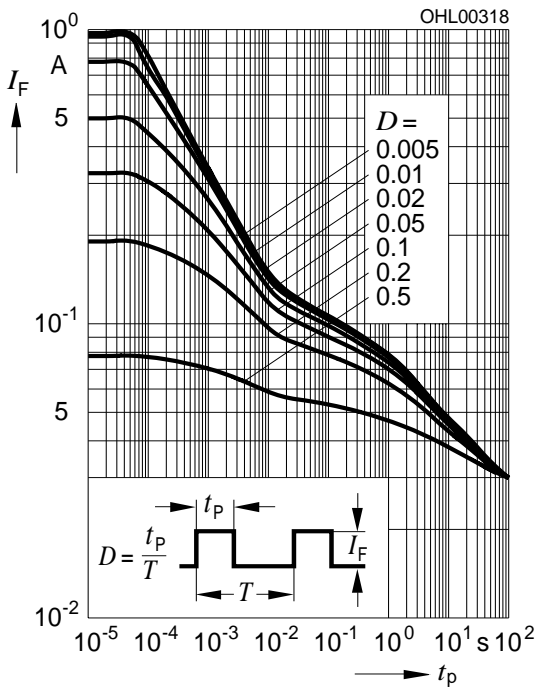


**Relative Lichtstärke  $I_V/I_{V(25\text{ }^\circ\text{C})} = f(T_A)$**   
**Relative Luminous Intensity**

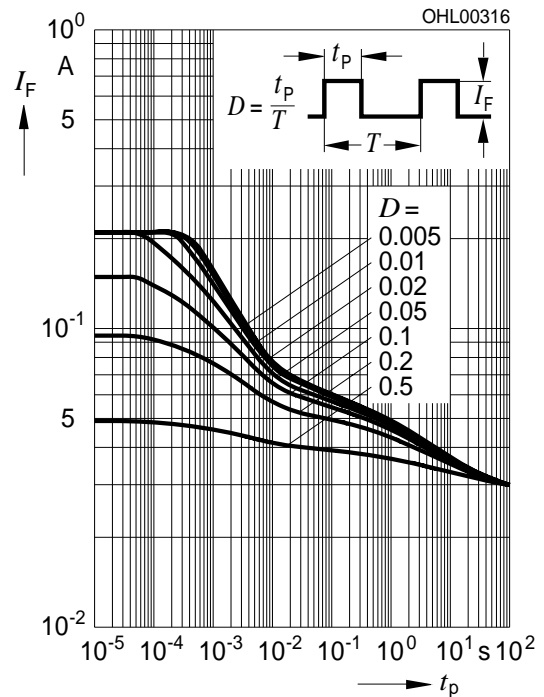
$I_F = 20\text{ mA}$



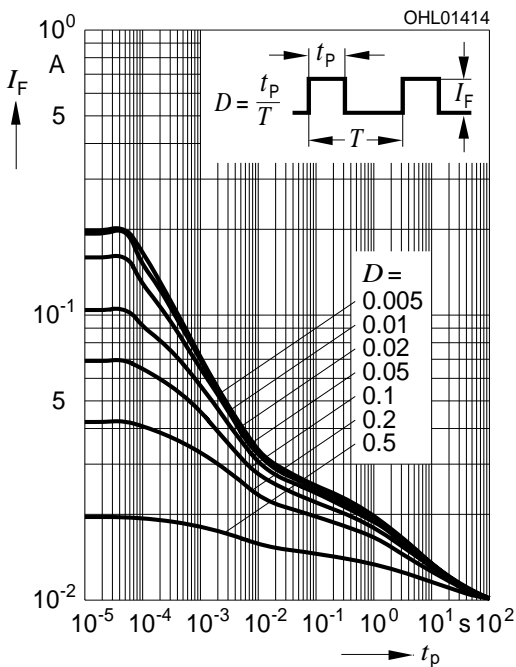
**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D =$  parameter,  $T_A = 25\text{ °C}$   
**LS, LA, LO**



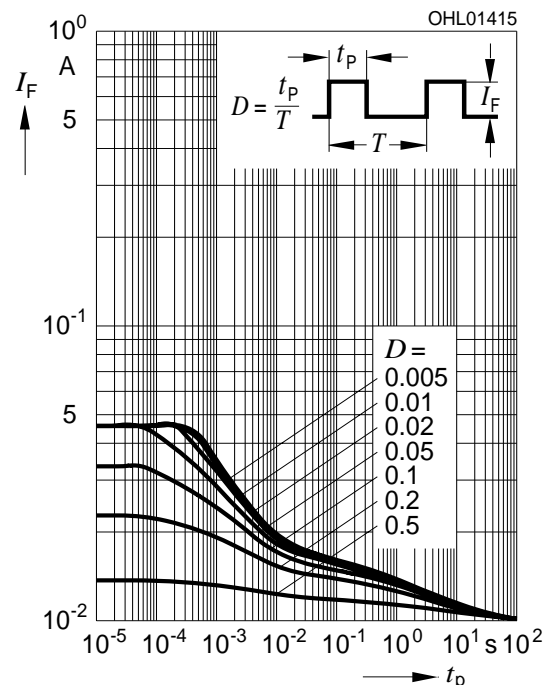
**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D =$  parameter,  $T_A = 25\text{ °C}$   
**LY**



**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D =$  parameter,  $T_A = 85\text{ °C}$   
**LS, LA, LO**



**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D =$  parameter,  $T_A = 85\text{ °C}$   
**LY**

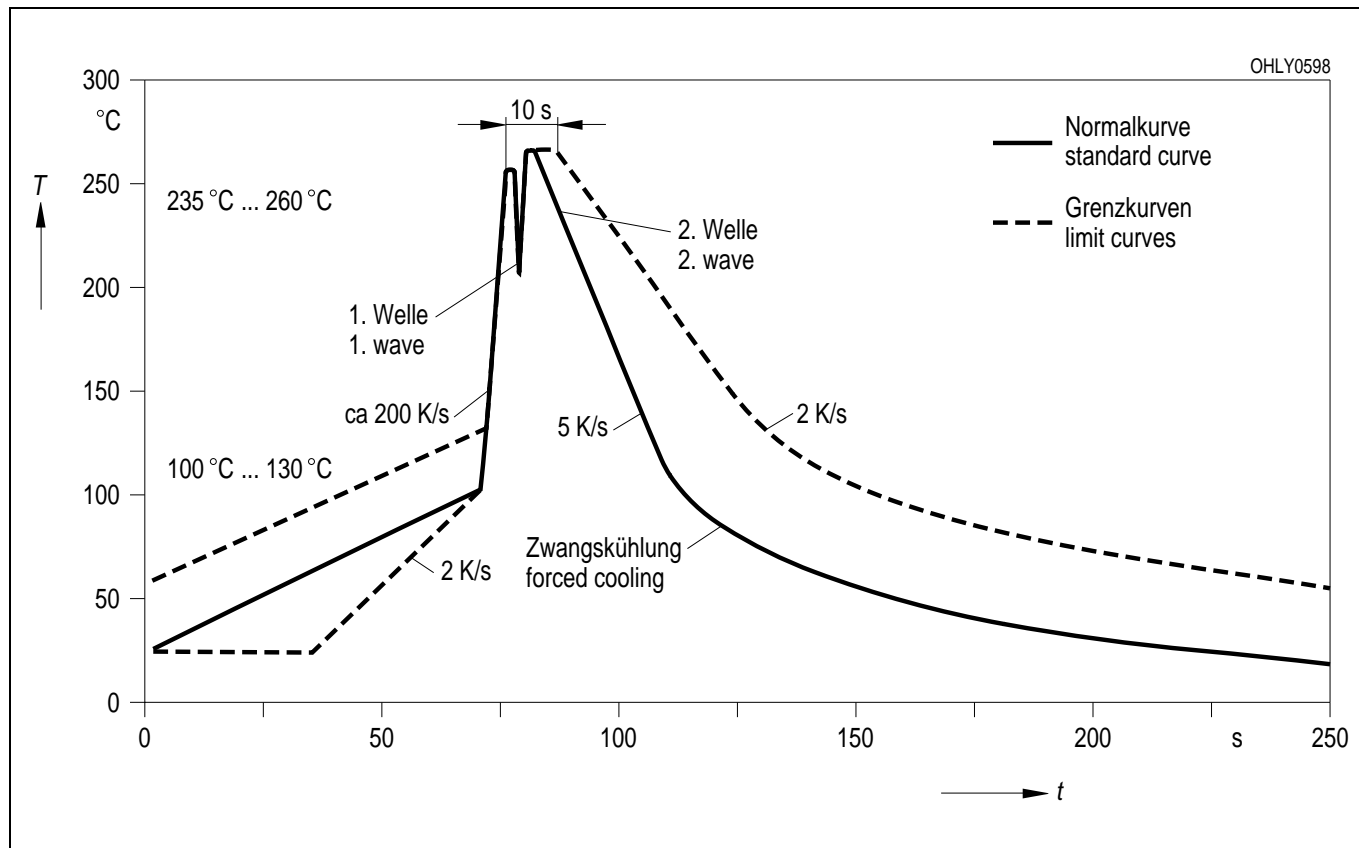




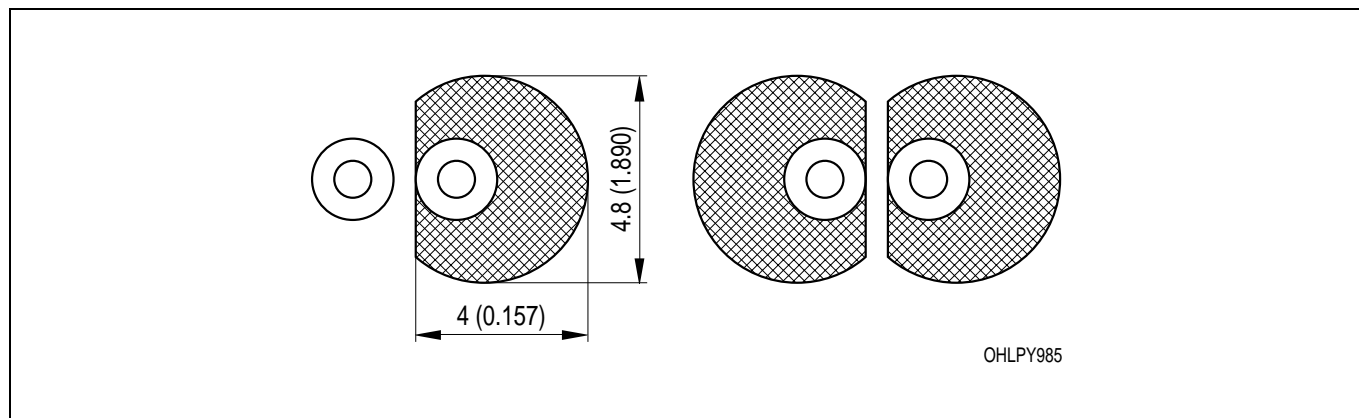


**Lötbedingungen**  
**Soldering Conditions**

**Wellenlöten (TTW)** (nach CECC 00802)  
**TTW Soldering** (acc. to CECC 00802)



**Empfohlenes Lötpaddesign** Wellenlöten (TTW)  
**Recommended Solder Pad** TTW Soldering



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch)

**Revision History: 2001-02-13**

Previous Version: 2001-02-13

Page	Subjects (major changes since last revision)

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